

FEATURES

- **Low Noise:** 20 μ V_{RMS} (10Hz to 100kHz)
- **Output Current:** 300mA
- **Low Quiescent Current:** 30 μ A
- **Wide Input Voltage Range:** 1.8V to 20V
- **Low Dropout Voltage:** 270mV
- **Very Low Shutdown Current:** < 1 μ A
- No Protection Diodes Needed
- Fixed Output Voltages: 1.5V, 1.8V, 2.5V, 3V, 3.3V, 5V
- Adjustable Output from 1.22V to 20V
- Stable with 3.3 μ F Output Capacitor
- Stable with Aluminum, Tantalum or Ceramic Capacitors
- Reverse Battery Protection
- No Reverse Current
- Overcurrent and Overtemperature Protected
- 8-Lead MSOP Package

APPLICATIONS

- Cellular Phones
- Battery-Powered Systems
- Noise-Sensitive Instrumentation Systems

DESCRIPTION

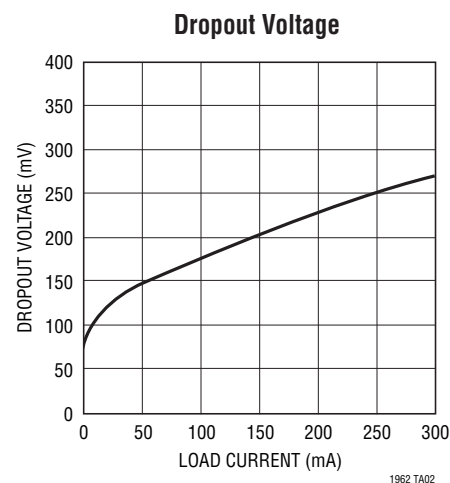
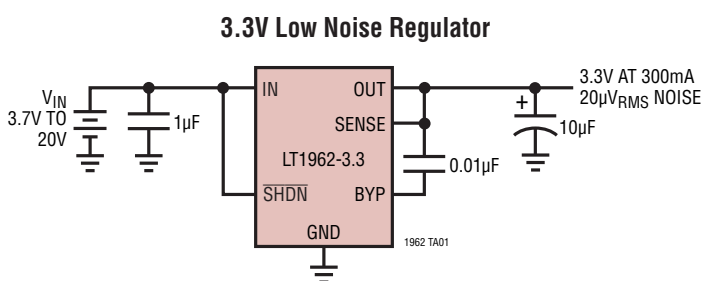
The **LT[®]1962** series are micropower, low noise, low dropout regulators. The devices are capable of supplying 300mA of output current with a dropout voltage of 270mV. Designed for use in battery-powered systems, the low 30 μ A quiescent current makes them an ideal choice. Quiescent current is well controlled; it does not rise in dropout as it does with many other regulators.

A key feature of the LT1962 regulators is low output noise. With the addition of an external 0.01 μ F bypass capacitor, output noise drops to 20 μ V_{RMS} over a 10Hz to 100kHz bandwidth. The LT1962 regulators are stable with output capacitors as low as 3.3 μ F. Small ceramic capacitors can be used without the series resistance required by other regulators.

Internal protection circuitry includes reverse battery protection, current limiting, thermal limiting and reverse current protection. The parts come in fixed output voltages of 1.5V, 1.8V, 2.5V, 3V, 3.3V and 5V, and as an adjustable device with a 1.22V reference voltage. The LT1962 regulators are available in the 8-lead MSOP package.

LT, LT, LTC, LTM, Linear Technology, the Linear logo and Burst Mode are registered trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners.

TYPICAL APPLICATION



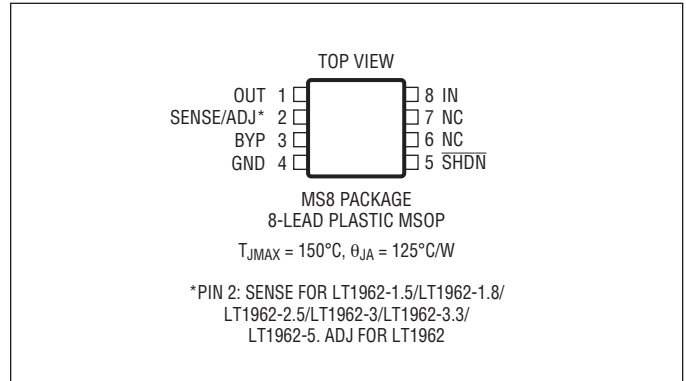
LT1962 Series

ABSOLUTE MAXIMUM RATINGS

(Note 1)

IN Pin Voltage	±20V
OUT Pin Voltage.....	±20V
Input to Output Differential Voltage (Note 2).....	±20V
SENSE Pin Voltage.....	±20V
ADJ Pin Voltage	±7V
BYP Pin Voltage	±0.6V
SHDN Pin Voltage	±20V
Output Short-Circuit Duration	Indefinite
Operating Junction Temperature Range (Note 3)	-40°C to 125°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec).....	300°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT1962EMS8#PBF	LT1962EMS8#TRPBF	LTML	8-Lead Plastic MSOP	-40°C to 125°C
LT1962IMS8#PBF	LT1962IMS8#TRPBF	LTML	8-Lead Plastic MSOP	-40°C to 125°C
LT1962EMS8-1.5#PBF	LT1962EMS8-1.5#TRPBF	LTSZ	8-Lead Plastic MSOP	-40°C to 125°C
LT1962EMS8-1.8#PBF	LT1962EMS8-1.8#TRPBF	LTTA	8-Lead Plastic MSOP	-40°C to 125°C
LT1962EMS8-2.5#PBF	LT1962EMS8-2.5#TRPBF	LTPT	8-Lead Plastic MSOP	-40°C to 125°C
LT1962EMS8-3#PBF	LT1962EMS8-3#TRPBF	LTPQ	8-Lead Plastic MSOP	-40°C to 125°C
LT1962EMS8-3.3#PBF	LT1962EMS8-3.3#TRPBF	LTPS	8-Lead Plastic MSOP	-40°C to 125°C
LT1962EMS8-5#PBF	LT1962EMS8-5#TRPBF	LTPR	8-Lead Plastic MSOP	-40°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container. Consult LTC Marketing for information on nonstandard lead based finish parts.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandreeel/>

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
Minimum Operating Voltage	LT1962 $I_{LOAD} = 300\text{mA}$ (Notes 4, 12)	●	1.8	2.3	V	
Regulated Output Voltage (Notes 4, 5)	LT1962-1.5 $V_{IN} = 2\text{V}$, $I_{LOAD} = 1\text{mA}$ $2.5\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	1.485	1.500	1.515	V
	LT1962-1.8 $V_{IN} = 2.3\text{V}$, $I_{LOAD} = 1\text{mA}$ $2.8\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	1.462	1.500	1.538	V
	LT1962-1.8 $V_{IN} = 2.3\text{V}$, $I_{LOAD} = 1\text{mA}$ $2.8\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	1.782	1.800	1.818	V
	LT1962-2.5 $V_{IN} = 3\text{V}$, $I_{LOAD} = 1\text{mA}$ $3.5\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	1.755	1.800	1.845	V
	LT1962-2.5 $V_{IN} = 3\text{V}$, $I_{LOAD} = 1\text{mA}$ $3.5\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	2.475	2.500	2.525	V
	LT1962-3 $V_{IN} = 3.5\text{V}$, $I_{LOAD} = 1\text{mA}$ $4\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	2.435	2.500	2.565	V
	LT1962-3 $V_{IN} = 3.5\text{V}$, $I_{LOAD} = 1\text{mA}$ $4\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	2.970	3.000	3.030	V
LT1962-3.3 $V_{IN} = 3.8\text{V}$, $I_{LOAD} = 1\text{mA}$ $4.3\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	2.925	3.000	3.075	V	
LT1962-3.3 $V_{IN} = 3.8\text{V}$, $I_{LOAD} = 1\text{mA}$ $4.3\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	3.267	3.300	3.333	V	
	●	3.220	3.300	3.380	V	
LT1962-5 $V_{IN} = 5.5\text{V}$, $I_{LOAD} = 1\text{mA}$ $6\text{V} < V_{IN} < 20\text{V}$, $1\text{mA} < I_{LOAD} < 300\text{mA}$	●	4.950	5.000	5.050	V	
	●	4.875	5.000	5.125	V	

1962fb

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
ADJ Pin Voltage (Notes 4, 5)	LT1962 $V_{IN} = 2V, I_{LOAD} = 1mA$ $2.3V < V_{IN} < 20V, 1mA < I_{LOAD} < 300mA$		1.208	1.220	1.232	V
		●	1.190	1.220	1.250	V
Line Regulation	LT1962-1.5	●	1	5	mV	
	LT1962-1.8	●	1	5	mV	
	LT1962-2.5	●	1	5	mV	
	LT1962-3	●	1	5	mV	
	LT1962-3.3	●	1	5	mV	
	LT1962-5	●	1	5	mV	
	LT1962 (Note 4)	●	1	5	mV	
Load Regulation	LT1962-1.5	●	3	8	mV	
				15	mV	
	LT1962-1.8	●	4	9	mV	
				18	mV	
	LT1962-2.5	●	5	12	mV	
				25	mV	
	LT1962-3	●	7	15	mV	
			30	mV		
Dropout Voltage $V_{IN} = V_{OUT(NOMINAL)}$ (Notes 6, 7, 12)	LT1962-1.5	●	0.10	0.15	V	
				0.21	V	
	LT1962-1.8	●	0.15	0.20	V	
				0.28	V	
	LT1962-2.5	●	0.18	0.24	V	
				0.33	V	
GND Pin Current $V_{IN} = V_{OUT(NOMINAL)}$ (Notes 6, 8)	LT1962-1.5	●	30	75	μA	
	LT1962-1.8	●	65	120	μA	
	LT1962-2.5	●	1.1	1.6	mA	
	LT1962-3	●	2	3	mA	
Output Voltage Noise	LT1962-3.3	●	8	12	mA	
	LT1962-5	●	8	12	mA	
Output Voltage Noise	$C_{OUT} = 10\mu\text{F}, C_{BYP} = 0.01\mu\text{F}, I_{LOAD} = 300mA, BW = 10\text{Hz to } 100\text{kHz}$		20		μV_{RMS}	
ADJ Pin Bias Current	(Notes 4, 9)		30	100	nA	
Shutdown Threshold	LT1962-1.5	●	0.8	2	V	
	LT1962-1.8	●	0.25	0.65	V	
SHDN Pin Current (Note 10)	LT1962-2.5		0.01	0.5	μA	
	LT1962-3		1	5	μA	
Quiescent Current in Shutdown	$V_{IN} = 6V, V_{SHDN} = 0V$		0.1	1	μA	
Ripple Rejection	$V_{IN} - V_{OUT} = 1.5V (Avg), V_{RIPPLE} = 0.5V_{P-P}, f_{RIPPLE} = 120\text{Hz}, I_{LOAD} = 300mA$		55	65	dB	
Current Limit	LT1962-3.3		700		mA	
	LT1962-5	●	320		mA	
Input Reverse Leakage Current	$V_{IN} = -20V, V_{OUT} = 0V$	●		1	mA	

LT1962 Series

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
Reverse Output Current (Note 11)	LT1962-1.5	$V_{OUT} = 1.5\text{V}, V_{IN} < 1.5\text{V}$		10	20	μA
	LT1962-1.8	$V_{OUT} = 1.8\text{V}, V_{IN} < 1.8\text{V}$		10	20	μA
	LT1962-2.5	$V_{OUT} = 2.5\text{V}, V_{IN} < 2.5\text{V}$		10	20	μA
	LT1962-3	$V_{OUT} = 3\text{V}, V_{IN} < 3\text{V}$		10	20	μA
	LT1962-3.3	$V_{OUT} = 3.3\text{V}, V_{IN} < 3.3\text{V}$		10	20	μA
	LT1962-5	$V_{OUT} = 5\text{V}, V_{IN} < 5\text{V}$		10	20	μA
	LT1962 (Note 4)	$V_{OUT} = 1.22\text{V}, V_{IN} < 1.22\text{V}$		5	10	μA

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: Absolute maximum input to output differential voltage cannot be achieved with all combinations of rated IN pin and OUT pin voltages. With the IN pin at 20V, the OUT pin may not be pulled below 0V. The total measured voltage from in to out can not exceed $\pm 20\text{V}$.

Note 3: The LT1962 is tested and specified under pulse load conditions such that $T_J \approx T_A$. The LT1962E is tested at $T_A = 25^\circ\text{C}$ and performance is guaranteed from 0°C to 125°C . Performance of the LT1962E over the full -40°C to 125°C operating temperature range is assured by design, characterization, and correlation with statistical process controls. The LT1962I is guaranteed over the full -40°C to 125°C operating junction temperature range.

Note 4: The LT1962 (adjustable version) is tested and specified for these conditions with the ADJ pin connected to the OUT pin.

Note 5: Operating conditions are limited by maximum junction temperature. The regulated output voltage specification will not apply for all possible combinations of input voltage and output current. When operating at maximum input voltage, the output current range must be limited. When operating at maximum output current, the input voltage range must be limited.

Note 6: To satisfy requirements for minimum input voltage, the LT1962 (adjustable version) is tested and specified for these conditions with an external resistor divider (two 250k resistors) for an output voltage of 2.44V. The external resistor divider will add a $5\mu\text{A}$ DC load on the output.

Note 7: Dropout voltage is the minimum input to output voltage differential needed to maintain regulation at a specified output current. In dropout, the output voltage will be equal to: $V_{IN} - V_{DROPOUT}$.

Note 8: GND pin current is tested with $V_{IN} = V_{OUT(NOMINAL)}$ or $V_{IN} = 2.3\text{V}$ (whichever is greater) and a current source load. This means the device is tested while operating in its dropout region. This is the worst-case GND pin current. The GND pin current will decrease slightly at higher input voltages.

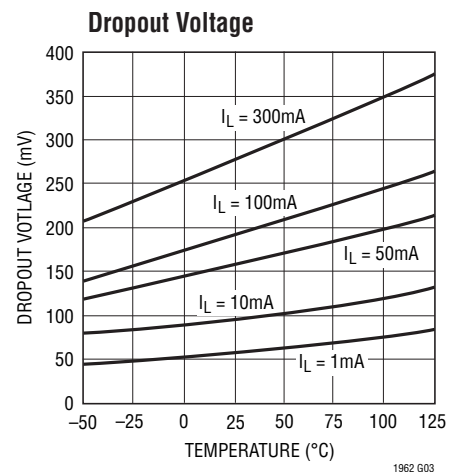
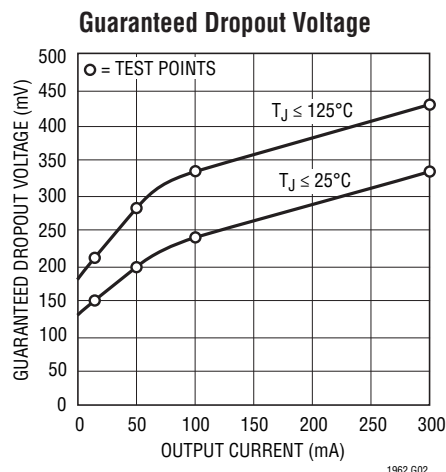
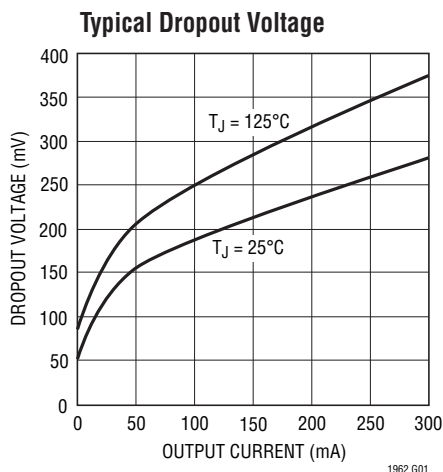
Note 9: ADJ pin bias current flows into the ADJ pin.

Note 10: SHDN pin current flows into the SHDN pin. This current is included in the specification for GND pin current.

Note 11: Reverse output current is tested with the IN pin grounded and the OUT pin forced to the rated output voltage. This current flows into the OUT pin and out the GND pin.

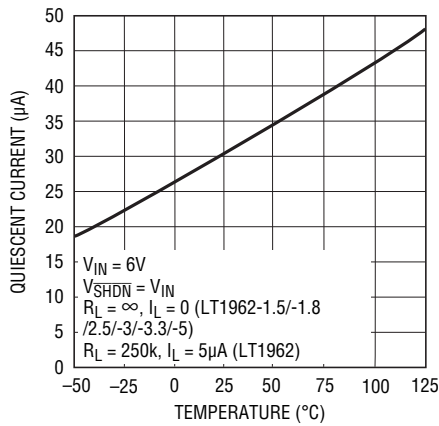
Note 12: For the LT1962, LT1962-1.5 and LT1962-1.8 dropout voltage will be limited by the minimum input voltage specification under some output voltage/load conditions. See the curve of Minimum Input Voltage in the Typical Performance Characteristics section. For other fixed voltage versions of the LT1962, the minimum input voltage is limited by the dropout voltage.

TYPICAL PERFORMANCE CHARACTERISTICS



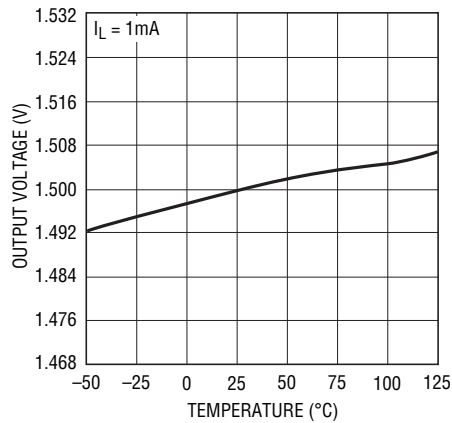
TYPICAL PERFORMANCE CHARACTERISTICS

Quiescent Current



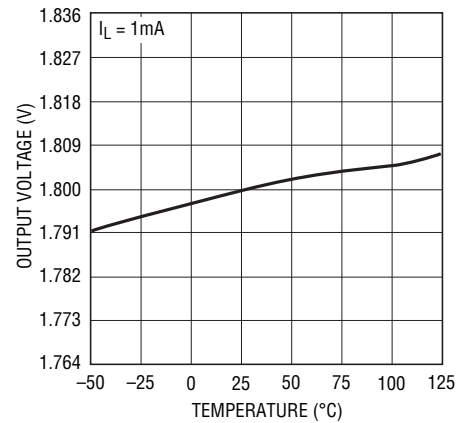
1962 G04

LT1962-1.5 Output Voltage



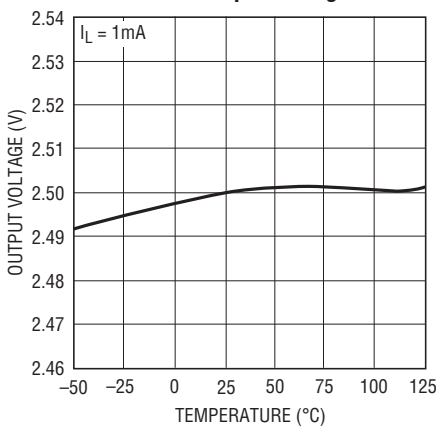
1962 G05

LT1962-1.8 Output Voltage



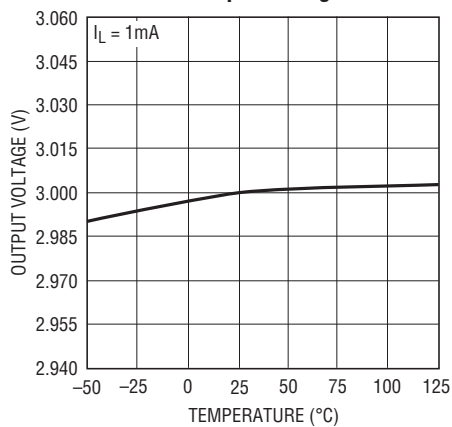
1962 G06

LT1962-2.5 Output Voltage



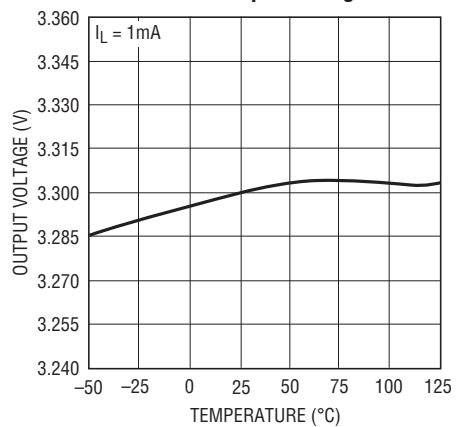
1962 G07

LT1962-3 Output Voltage



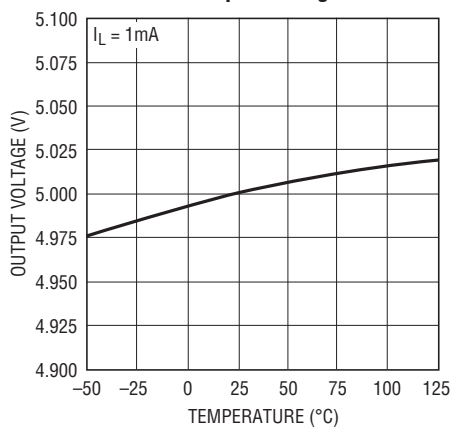
1962 G08

LT1962-3.3 Output Voltage



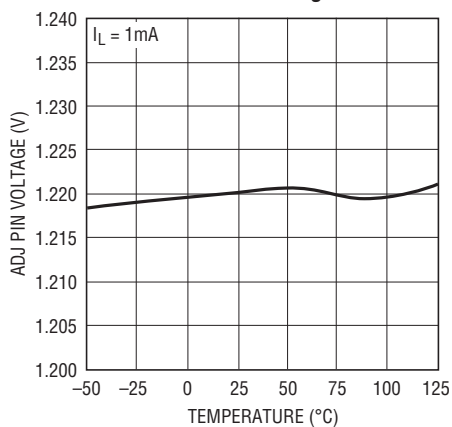
1962 G09

LT1962-5 Output Voltage



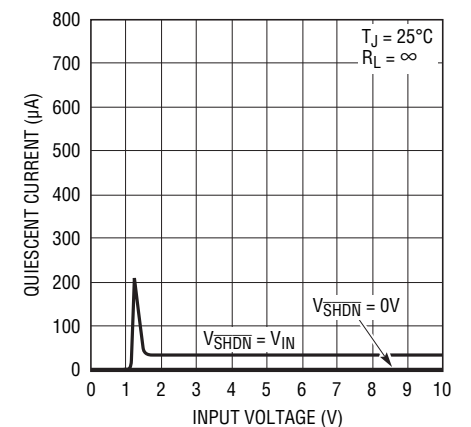
1962 G10

LT1962 ADJ Pin Voltage



1962 G11

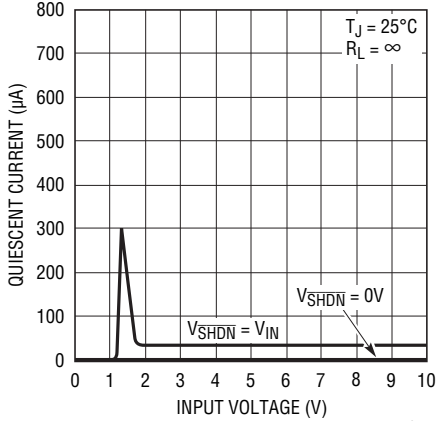
LT1962-1.5 Quiescent Current



1962 G12

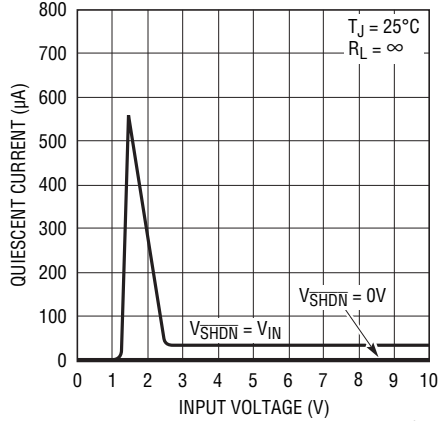
TYPICAL PERFORMANCE CHARACTERISTICS

LT1962-1.8 Quiescent Current



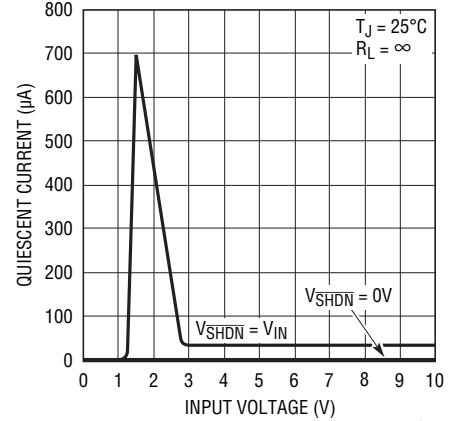
1962 G13

LT1962-2.5 Quiescent Current



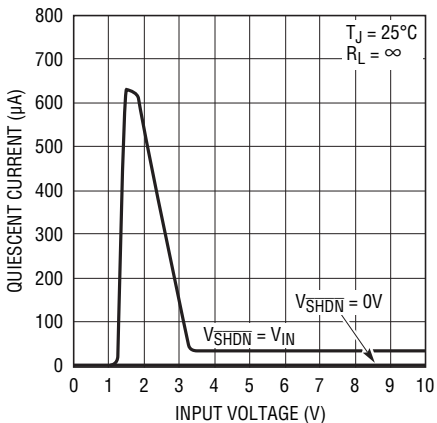
1962 G14

LT1962-3 Quiescent Current



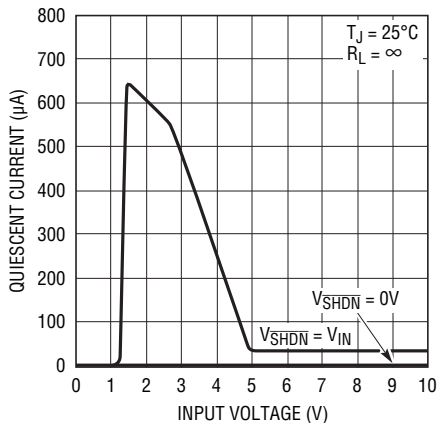
1962 G15

LT1962-3.3 Quiescent Current



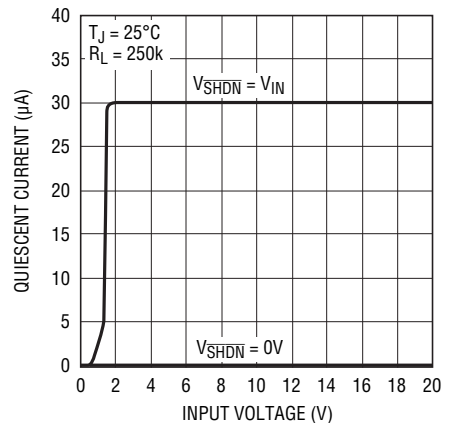
1962 G16

LT1962-5 Quiescent Current



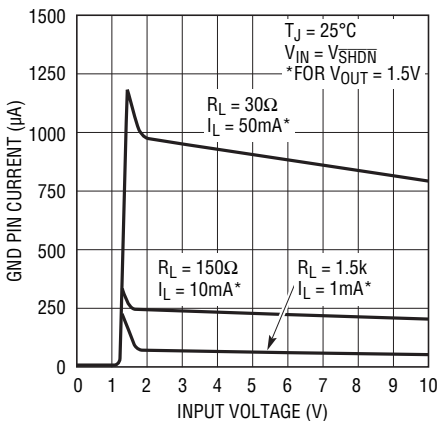
1962 G17

LT1962 Quiescent Current



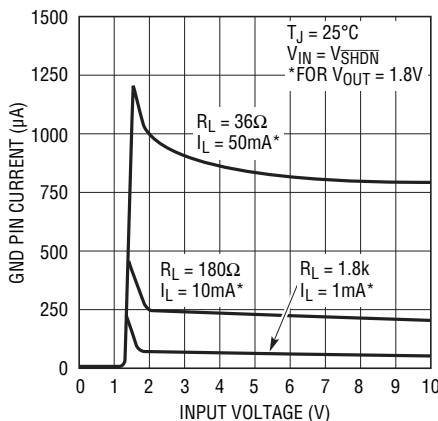
1962 G18

LT1962-1.5 GND Pin Current



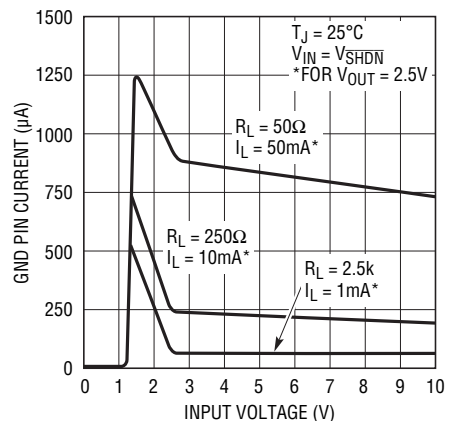
1962 G19

LT1962-1.8 GND Pin Current



1962 G20

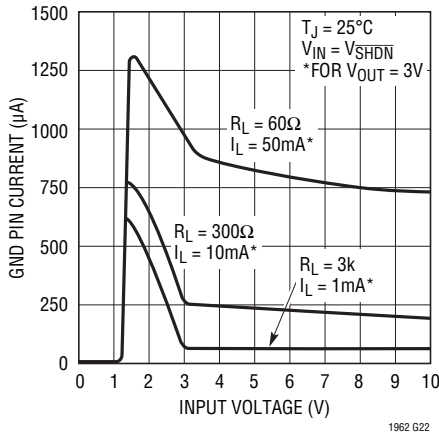
LT1962-2.5 GND Pin Current



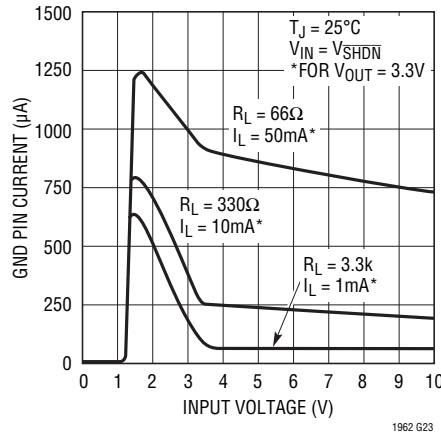
1962 G21

TYPICAL PERFORMANCE CHARACTERISTICS

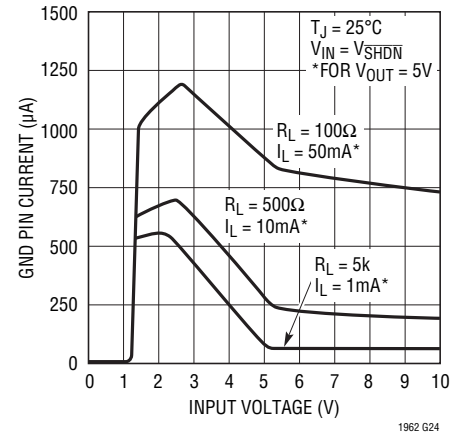
LT1962-3 GND Pin Current



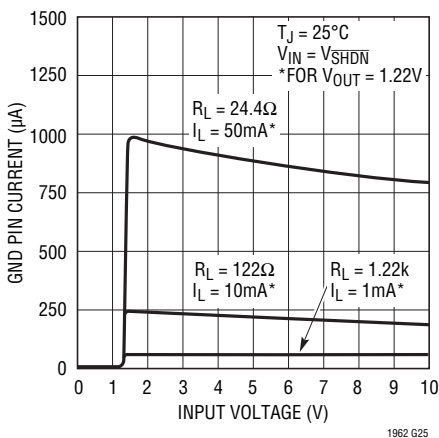
LT1962-3.3 GND Pin Current



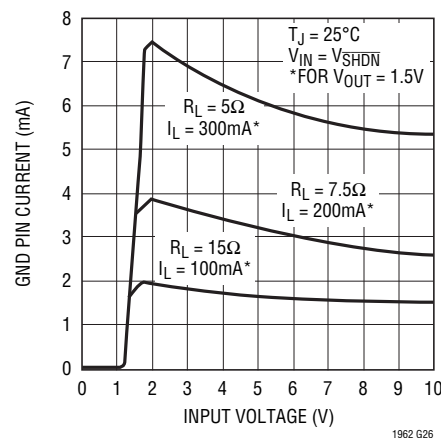
LT1962-5 GND Pin Current



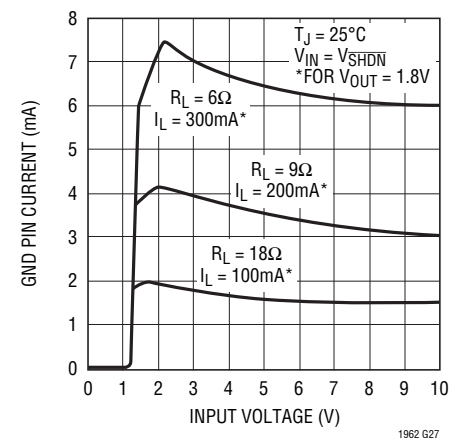
LT1962 GND Pin Current



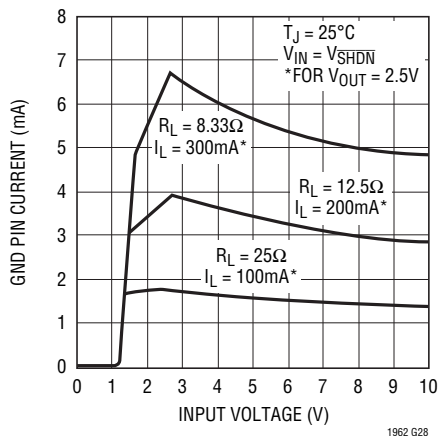
LT1962-1.5 GND Pin Current



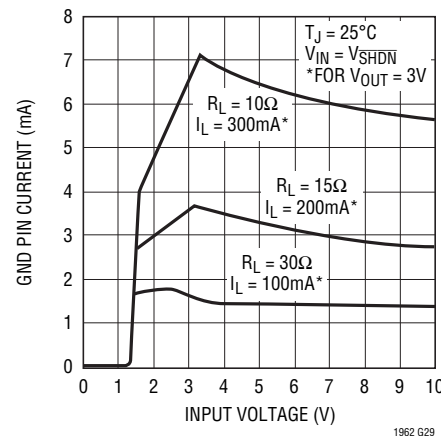
LT1962-1.8 GND Pin Current



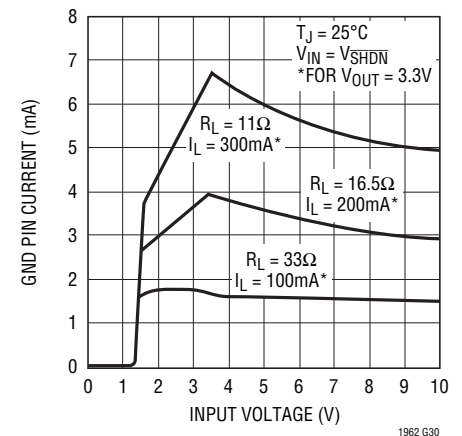
LT1962-2.5 GND Pin Current



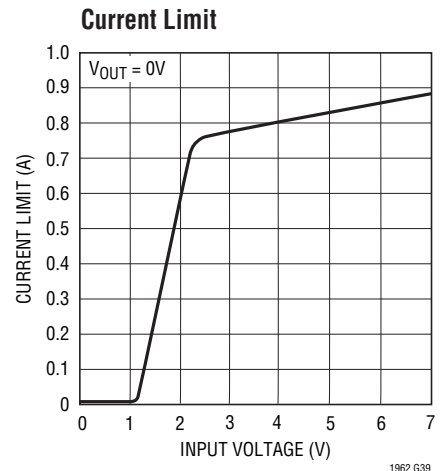
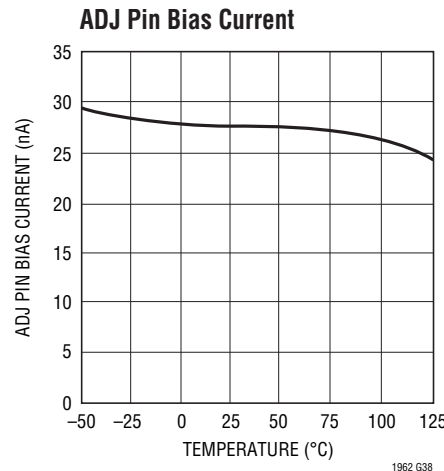
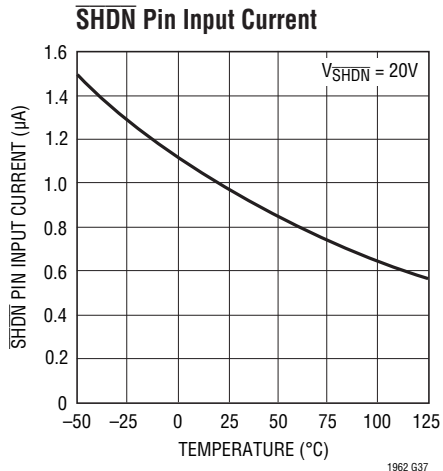
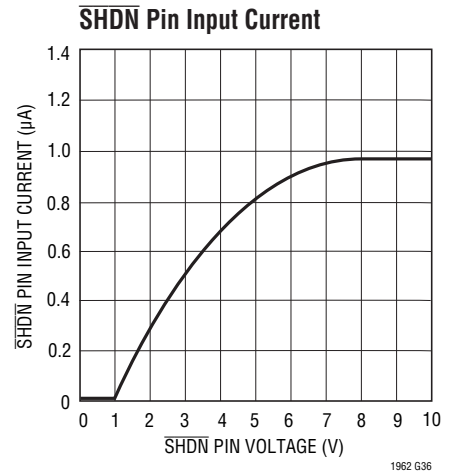
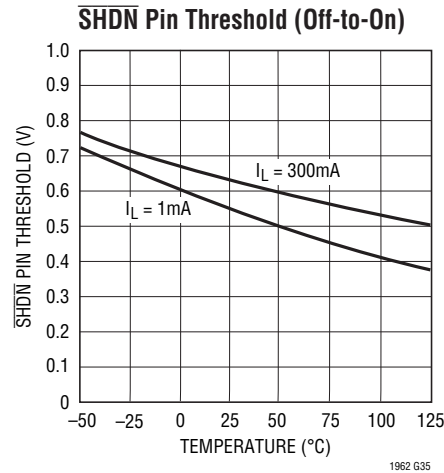
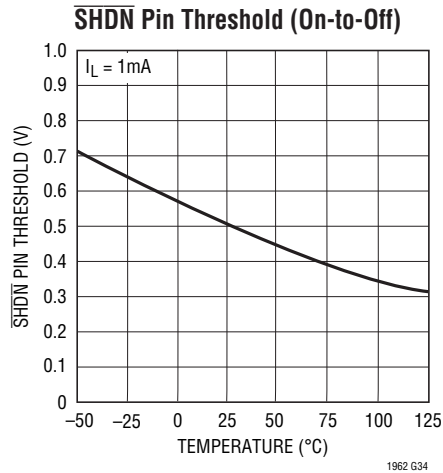
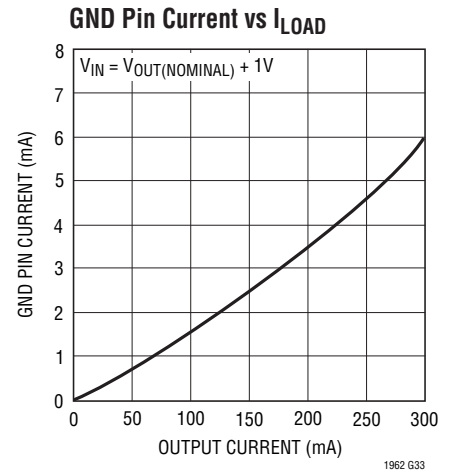
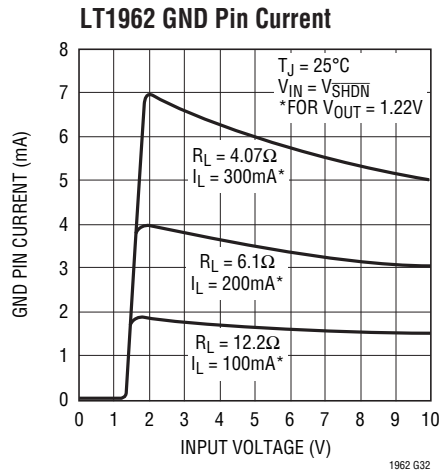
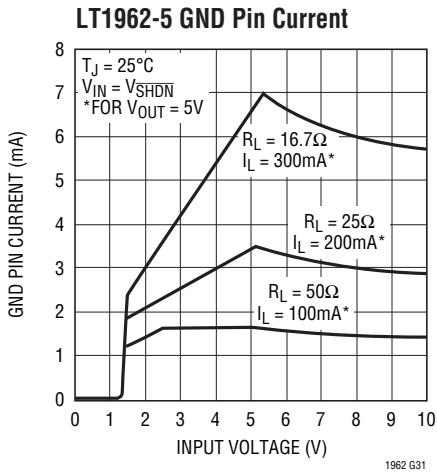
LT1962-3 GND Pin Current



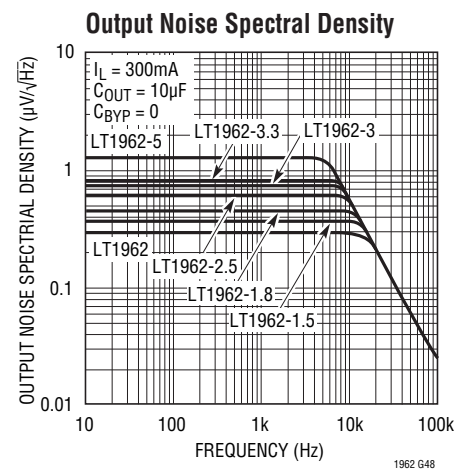
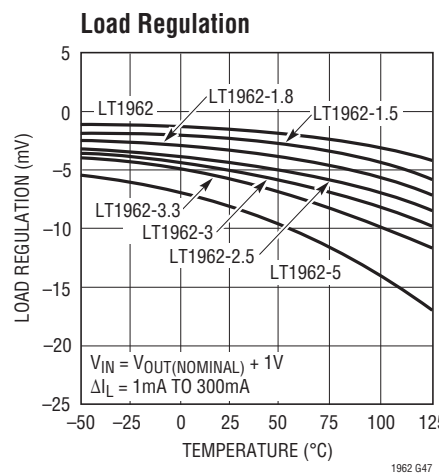
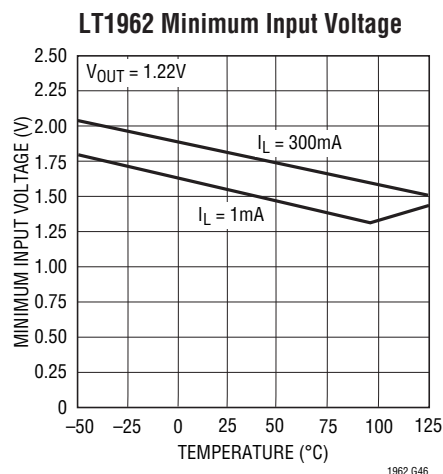
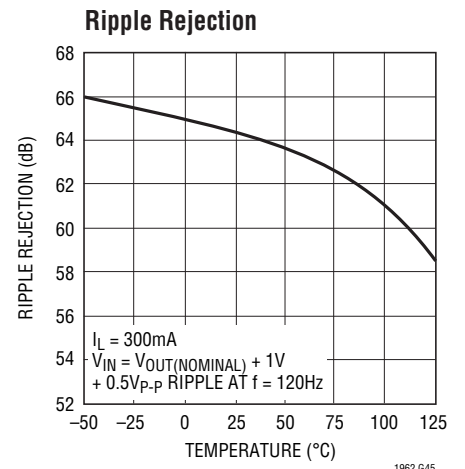
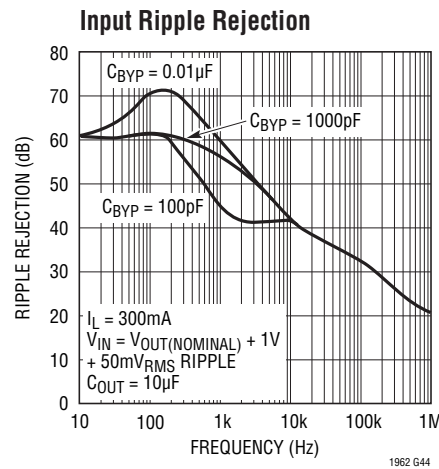
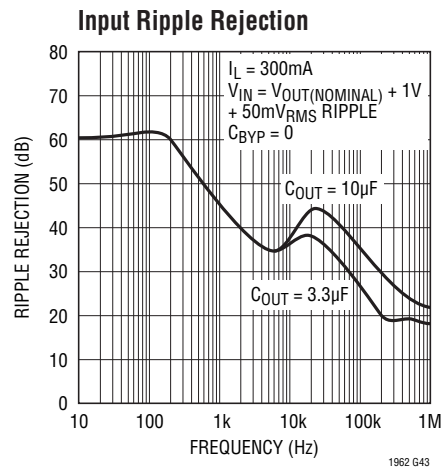
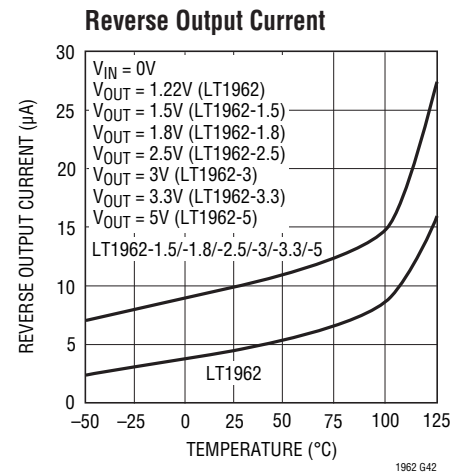
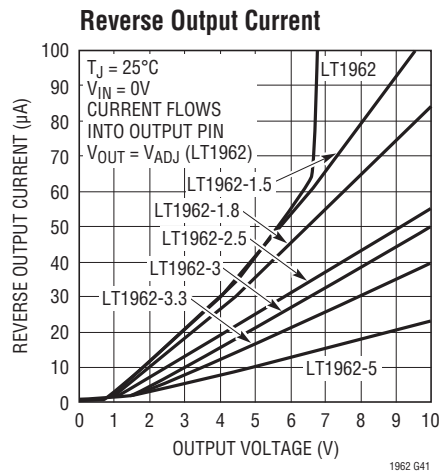
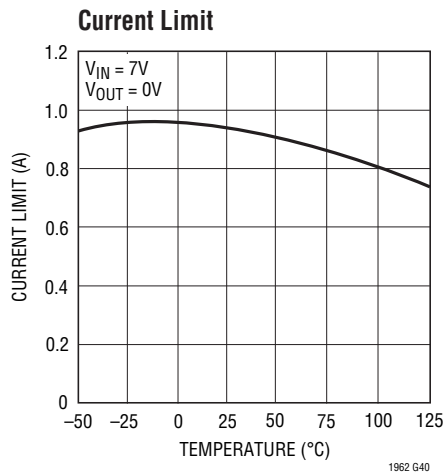
LT1962-3.3 GND Pin Current



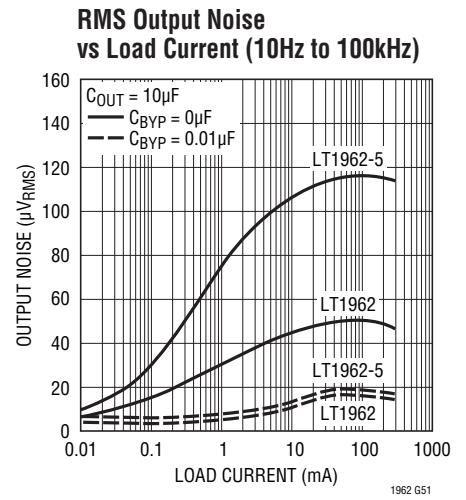
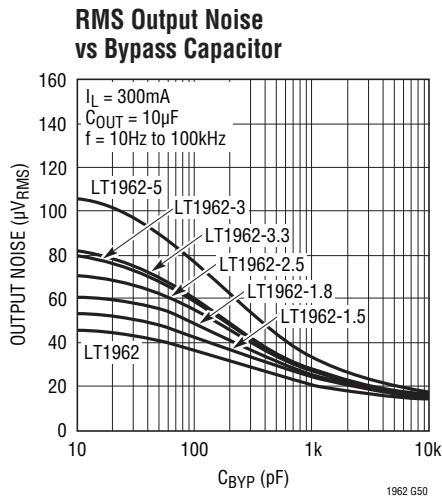
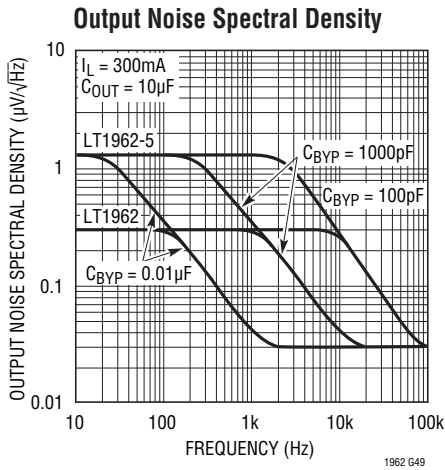
TYPICAL PERFORMANCE CHARACTERISTICS



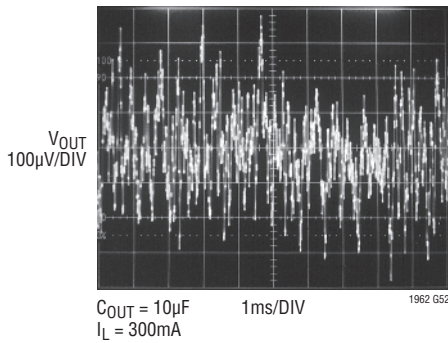
TYPICAL PERFORMANCE CHARACTERISTICS



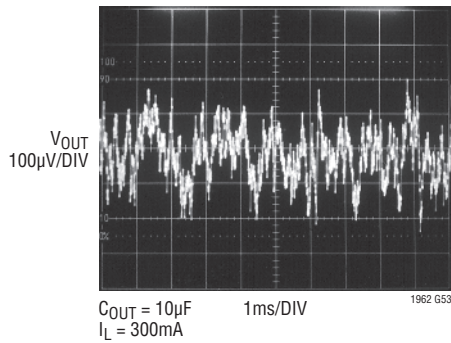
TYPICAL PERFORMANCE CHARACTERISTICS



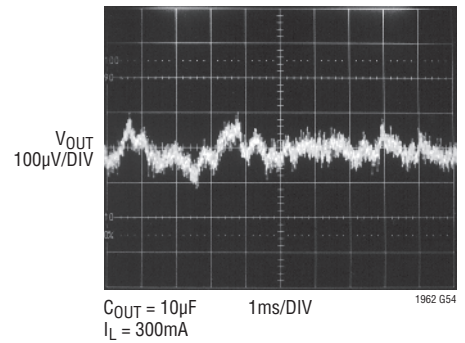
LT1962-5 10Hz to 100kHz Output Noise ($C_{BYP} = 0$)



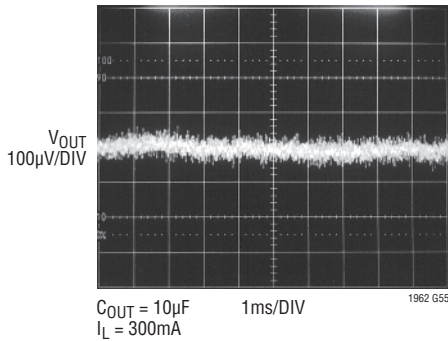
LT1962-5 10Hz to 100kHz Output Noise ($C_{BYP} = 100\text{pF}$)



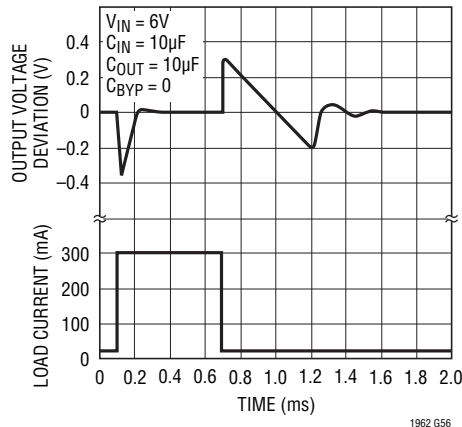
LT1962-5 10Hz to 100kHz Output Noise ($C_{BYP} = 1000\text{pF}$)



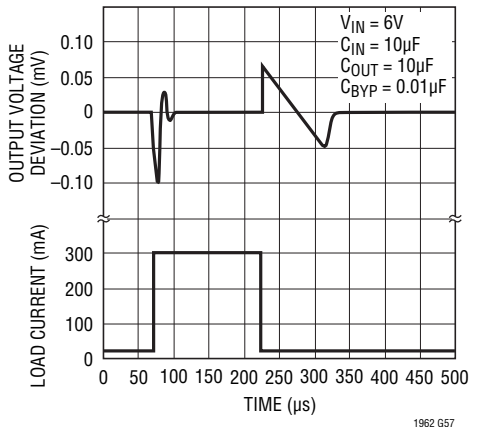
LT1962-5 10Hz to 100kHz Output Noise ($C_{BYP} = 0.01\mu\text{F}$)



LT1962-5 Transient Response



LT1962-5 Transient Response



PIN FUNCTIONS

OUT (Pin 1): Output. The output supplies power to the load. A minimum output capacitor of $3.3\mu\text{F}$ is required to prevent oscillations. Larger output capacitors will be required for applications with large transient loads to limit peak voltage transients. See the Applications Information section for more information on output capacitance and reverse output characteristics.

SENSE (Pin 2): Sense. For fixed voltage versions of the LT1962 (LT1962-1.5/LT1962-1.8/LT1962-2.5/LT1962-3/LT1962-3.3/LT1962-5), the SENSE pin is the input to the error amplifier. Optimum regulation will be obtained at the point where the SENSE pin is connected to the OUT pin of the regulator. In critical applications, small voltage drops are caused by the resistance (R_P) of PC traces between the regulator and the load. These may be eliminated by connecting the SENSE pin to the output at the load as shown in Figure 1 (Kelvin Sense Connection). Note that the voltage drop across the external PC traces will add to the dropout voltage of the regulator. The SENSE pin bias current is $10\mu\text{A}$ at the nominal rated output voltage. The SENSE pin can be pulled below ground (as in a dual supply system where the regulator load is returned to a negative supply) and still allow the device to start and operate.

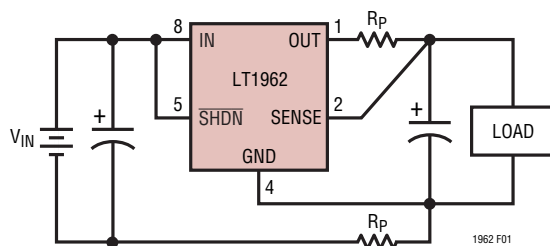


Figure 1. Kelvin Sense Connection

ADJ (Pin 2): Adjust. For the adjustable LT1962, this is the input to the error amplifier. This pin is internally clamped to $\pm 7\text{V}$. It has a bias current of 30nA which flows into the pin. The ADJ pin voltage is 1.22V referenced to ground and the output voltage range is 1.22V to 20V .

BYP (Pin 3): Bypass. The BYP pin is used to bypass the reference of the LT1962 to achieve low noise performance from the regulator. The BYP pin is clamped internally to $\pm 0.6\text{V}$ (one V_{BE}). A small capacitor from the output to this pin will bypass the reference to lower the output voltage noise. A maximum value of $0.01\mu\text{F}$ can be used for reducing output voltage noise to a typical $20\mu\text{V}_{\text{RMS}}$ over a 10Hz to 100kHz bandwidth. If not used, this pin must be left unconnected.

GND (Pin 4): Ground.

SHDN (Pin 5): Shutdown. The $\overline{\text{SHDN}}$ pin is used to put the LT1962 regulators into a low power shutdown state. The output will be off when the $\overline{\text{SHDN}}$ pin is pulled low. The $\overline{\text{SHDN}}$ pin can be driven either by 5V logic or open-collector logic with a pull-up resistor. The pull-up resistor is required to supply the pull-up current of the open-collector gate, normally several microamperes, and the $\overline{\text{SHDN}}$ pin current, typically $1\mu\text{A}$. If unused, the $\overline{\text{SHDN}}$ pin must be connected to V_{IN} . The device will not function if the SHDN pin is not connected.

NC (Pins 6, 7): No Connect. These pins are not internally connected. For improved power handling capabilities, these pins can be connected to the PC board.

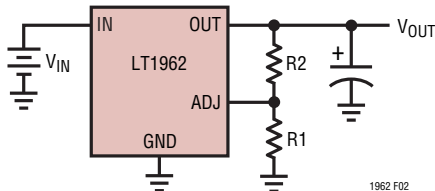
IN (Pin 8): Input. Power is supplied to the device through the IN pin. A bypass capacitor is required on this pin if the device is more than six inches away from the main input filter capacitor. In general, the output impedance of a battery rises with frequency, so it is advisable to include a bypass capacitor in battery-powered circuits. A bypass capacitor in the range of $1\mu\text{F}$ to $10\mu\text{F}$ is sufficient. The LT1962 regulators are designed to withstand reverse voltages on the IN pin with respect to ground and the OUT pin. In the case of a reverse input, which can happen if a battery is plugged in backwards, the device will act as if there is a diode in series with its input. There will be no reverse current flow into the regulator and no reverse voltage will appear at the load. The device will protect both itself and the load.

APPLICATIONS INFORMATION

The LT1962 series are 300mA low dropout regulators with micropower quiescent current and shutdown. The devices are capable of supplying 300mA at a dropout voltage of 300mV. Output voltage noise can be lowered to $20\mu\text{V}_{\text{RMS}}$ over a 10Hz to 100kHz bandwidth with the addition of a $0.01\mu\text{F}$ reference bypass capacitor. Additionally, the reference bypass capacitor will improve transient response of the regulator, lowering the settling time for transient load conditions. The low operating quiescent current ($30\mu\text{A}$) drops to less than $1\mu\text{A}$ in shutdown. In addition to the low quiescent current, the LT1962 regulators incorporate several protection features which make them ideal for use in battery-powered systems. The devices are protected against both reverse input and reverse output voltages. In battery backup applications where the output can be held up by a backup battery when the input is pulled to ground, the LT1962-X acts like it has a diode in series with its output and prevents reverse current flow. Additionally, in dual supply applications where the regulator load is returned to a negative supply, the output can be pulled below ground by as much as 20V and still allow the device to start and operate.

Adjustable Operation

The adjustable version of the LT1962 has an output voltage range of 1.22V to 20V. The output voltage is set by the ratio of two external resistors as shown in Figure 2. The device servos the output to maintain the ADJ pin voltage at 1.22V referenced to ground. The current in R1 is then equal to $1.22\text{V}/\text{R1}$ and the current in R2 is the current in



$$V_{\text{OUT}} = 1.22\text{V} \left(1 + \frac{\text{R2}}{\text{R1}} \right) + (I_{\text{ADJ}})(\text{R2})$$

$$V_{\text{ADJ}} = 1.22\text{V}$$

$$I_{\text{ADJ}} = 30\text{nA at } 25^\circ\text{C}$$

$$\text{OUTPUT RANGE} = 1.22\text{V to } 20\text{V}$$

Figure 2. Adjustable Operation

R1 plus the ADJ pin bias current. The ADJ pin bias current, 30nA at 25°C , flows through R2 into the ADJ pin. The output voltage can be calculated using the formula in Figure 2. The value of R1 should be no greater than 250k to minimize errors in the output voltage caused by the ADJ pin bias current. Note that in shutdown the output is turned off and the divider current will be zero.

The adjustable device is tested and specified with the ADJ pin tied to the OUT pin for an output voltage of 1.22V. Specifications for output voltages greater than 1.22V will be proportional to the ratio of the desired output voltage to 1.22V: $V_{\text{OUT}}/1.22\text{V}$. For example, load regulation for an output current change of 1mA to 300mA is -2mV typical at $V_{\text{OUT}} = 1.22\text{V}$. At $V_{\text{OUT}} = 12\text{V}$, load regulation is:

$$(12\text{V}/1.22\text{V})(-2\text{mV}) = -19.7\text{mV}$$

Bypass Capacitance and Low Noise Performance

The LT1962 regulators may be used with the addition of a bypass capacitor from V_{OUT} to the BYP pin to lower output voltage noise. A good quality low leakage capacitor is recommended. This capacitor will bypass the reference of the regulator, providing a low frequency noise pole. The noise pole provided by this bypass capacitor will lower the output voltage noise to as low as $20\mu\text{V}_{\text{RMS}}$ with the addition of a $0.01\mu\text{F}$ bypass capacitor. Using a bypass capacitor has the added benefit of improving transient response. With no bypass capacitor and a $10\mu\text{F}$ output capacitor, a 10mA to 300mA load step will settle to within 1% of its final value in less than $100\mu\text{s}$. With the addition of a $0.01\mu\text{F}$ bypass capacitor, the output will settle to within 1% for a 10mA to 300mA load step in less than $10\mu\text{s}$, with total output voltage deviation of less than 2% (see LT1962-5 Transient Response in the Typical Performance Characteristics section). However, regulator start-up time is proportional to the size of the bypass capacitor, slowing to 15ms with a $0.01\mu\text{F}$ bypass capacitor and $10\mu\text{F}$ output capacitor.

Output Capacitance and Transient Response

The LT1962 regulators are designed to be stable with a wide range of output capacitors. The ESR of the output capacitor affects stability, most notably with small capacitors. A minimum output capacitor of $3.3\mu\text{F}$ with an ESR of 3Ω or less is recommended to prevent oscillations.

APPLICATIONS INFORMATION

The LT1962-X is a micropower device and output transient response will be a function of output capacitance. Larger values of output capacitance decrease the peak deviations and provide improved transient response for larger load current changes. Bypass capacitors, used to decouple individual components powered by the LT1962, will increase the effective output capacitor value. With larger capacitors used to bypass the reference (for low noise operation), larger values of output capacitance are needed. For 100pF of bypass capacitance, 4.7μF of output capacitor is recommended. With a 1000pF bypass capacitor or larger, a 6.8μF output capacitor is recommended.

The shaded region of Figure 3 defines the range over which the LT1962 regulators are stable. The minimum ESR needed is defined by the amount of bypass capacitance used, while the maximum ESR is 3Ω.

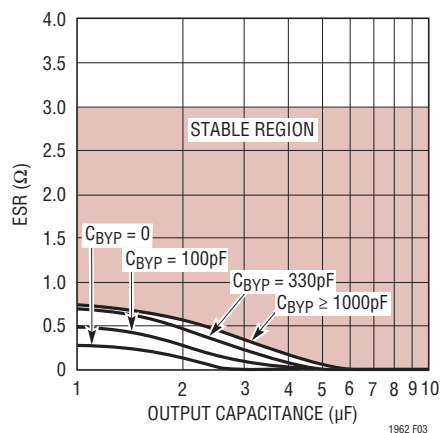


Figure 3. Stability

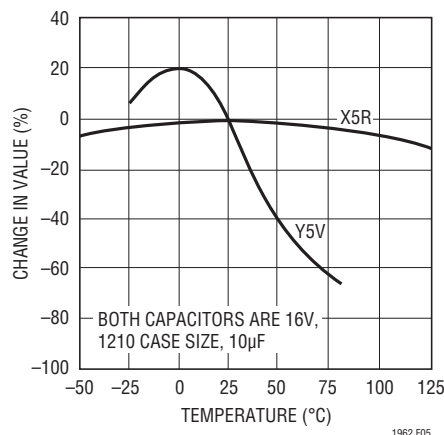


Figure 5. Ceramic Capacitor Temperature Characteristics

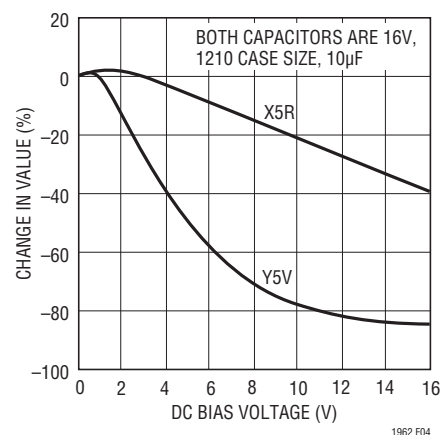


Figure 4. Ceramic Capacitor DC Bias Characteristics

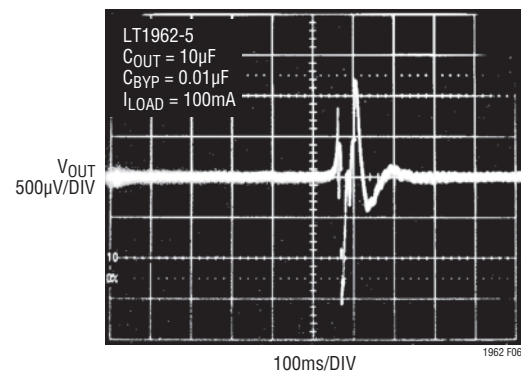


Figure 6. Noise Resulting from Tapping on a Ceramic Capacitor

APPLICATIONS INFORMATION

Voltage and temperature coefficients are not the only sources of problems. Some ceramic capacitors have a piezoelectric response. A piezoelectric device generates voltage across its terminals due to mechanical stress, similar to the way a piezoelectric accelerometer or microphone works. For a ceramic capacitor the stress can be induced by vibrations in the system or thermal transients. The resulting voltages produced can cause appreciable amounts of noise, especially when a ceramic capacitor is used for noise bypassing. A ceramic capacitor produced Figure 6's trace in response to light tapping from a pencil. Similar vibration induced behavior can masquerade as increased output voltage noise.

Thermal Considerations

The power handling capability of the device will be limited by the maximum rated junction temperature (125°C). The power dissipated by the device will be made up of two components:

1. Output current multiplied by the input/output voltage differential: $(I_{OUT})(V_{IN} - V_{OUT})$, and
2. GND pin current multiplied by the input voltage: $(I_{GND})(V_{IN})$.

The GND pin current can be found by examining the GND Pin Current curves in the Typical Performance Characteristics section. Power dissipation will be equal to the sum of the two components listed above.

The LT1962 series regulators have internal thermal limiting designed to protect the device during overload conditions. For continuous normal conditions, the maximum junction temperature rating of 125°C must not be exceeded. It is important to give careful consideration to all sources of thermal resistance from junction to ambient. Additional heat sources mounted nearby must also be considered.

For surface mount devices, heat sinking is accomplished by using the heat spreading capabilities of the PC board and its copper traces. Copper board stiffeners and plated through-holes can also be used to spread the heat generated by power devices.

The following table lists thermal resistance for several different board sizes and copper areas. All measurements were taken in still air on 1/16" FR-4 board with one ounce copper.

Table 1. Measured Thermal Resistance

COPPER AREA		BOARD AREA	THERMAL RESISTANCE (JUNCTION-TO-AMBIENT)
TOPSIDE*	BACKSIDE		
2500mm ²	2500mm ²	2500mm ²	110°C/W
1000mm ²	2500mm ²	2500mm ²	115°C/W
225mm ²	2500mm ²	2500mm ²	120°C/W
100mm ²	2500mm ²	2500mm ²	130°C/W
50mm ²	2500mm ²	2500mm ²	140°C/W

*Device is mounted on topside.

Calculating Junction Temperature

Example: Given an output voltage of 3.3V, an input voltage range of 4V to 6V, an output current range of 0mA to 100mA and a maximum ambient temperature of 50°C, what will the maximum junction temperature be?

The power dissipated by the device will be equal to:

$$I_{OUT(MAX)}(V_{IN(MAX)} - V_{OUT}) + I_{GND}(V_{IN(MAX)})$$

where,

$$I_{OUT(MAX)} = 100\text{mA}$$

$$V_{IN(MAX)} = 6\text{V}$$

$$I_{GND} \text{ at } (I_{OUT} = 100\text{mA}, V_{IN} = 6\text{V}) = 2\text{mA}$$

So,

$$P = 100\text{mA}(6\text{V} - 3.3\text{V}) + 2\text{mA}(6\text{V}) = 0.28\text{W}$$

The thermal resistance will be in the range of 110°C/W to 140°C/W depending on the copper area. So the junction temperature rise above ambient will be approximately equal to:

$$0.28\text{W}(125^\circ\text{C/W}) = 35.3^\circ\text{C}$$

The maximum junction temperature will then be equal to the maximum junction temperature rise above ambient plus the maximum ambient temperature or:

$$T_{JMAX} = 50^\circ\text{C} + 35.3^\circ\text{C} = 85.3^\circ\text{C}$$

APPLICATIONS INFORMATION

Protection Features

The LT1962 regulators incorporate several protection features which make them ideal for use in battery-powered circuits. In addition to the normal protection features associated with monolithic regulators, such as current limiting and thermal limiting, the devices are protected against reverse input voltages, reverse output voltages and reverse voltages from output to input.

Current limit protection and thermal overload protection are intended to protect the device against current overload conditions at the output of the device. For normal operation, the junction temperature should not exceed 125°C.

The input of the device will withstand reverse voltages of 20V. Current flow into the device will be limited to less than 1mA (typically less than 100µA) and no negative voltage will appear at the output. The device will protect both itself and the load. This provides protection against batteries which can be plugged in backward.

The output of the LT1962 can be pulled below ground without damaging the device. If the input is left open circuit or grounded, the output can be pulled below ground by 20V. For fixed voltage versions, the output will act like a large resistor, typically 500k or higher, limiting current flow to less than 40µA. For adjustable versions, the output will act like an open circuit; no current will flow out of the pin. If the input is powered by a voltage source, the output will source the short-circuit current of the device and will protect itself by thermal limiting. In this case, grounding the $\overline{\text{SHDN}}$ pin will turn off the device and stop the output from sourcing the short-circuit current.

The ADJ pin of the adjustable device can be pulled above or below ground by as much as 7V without damaging the device. If the input is left open circuit or grounded, the ADJ pin will act like an open circuit when pulled below ground and like a large resistor (typically 100k) in series with a diode when pulled above ground.

In situations where the ADJ pin is connected to a resistor divider that would pull the ADJ pin above its 7V clamp voltage if the output is pulled high, the ADJ pin input current must be limited to less than 5mA. For example, a resistor

divider is used to provide a regulated 1.5V output from the 1.22V reference when the output is forced to 20V. The top resistor of the resistor divider must be chosen to limit the current into the ADJ pin to less than 5mA when the ADJ pin is at 7V. The 13V difference between OUT and ADJ pin divided by the 5mA maximum current into the ADJ pin yields a minimum top resistor value of 2.6k.

In circuits where a backup battery is required, several different input/output conditions can occur. The output voltage may be held up while the input is either pulled to ground, pulled to some intermediate voltage or is left open circuit. Current flow back into the output will follow the curve shown in Figure 7.

When the IN pin of the LT1962 is forced below the OUT pin or the OUT pin is pulled above the IN pin, input current will typically drop to less than 2µA. This can happen if the input of the device is connected to a discharged (low voltage) battery and the output is held up by either a backup battery or a second regulator circuit. The state of the $\overline{\text{SHDN}}$ pin will have no effect on the reverse output current when the output is pulled above the input.

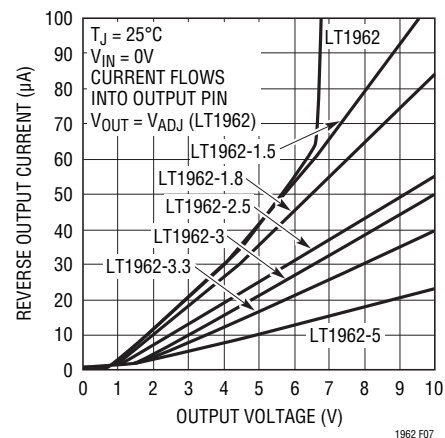
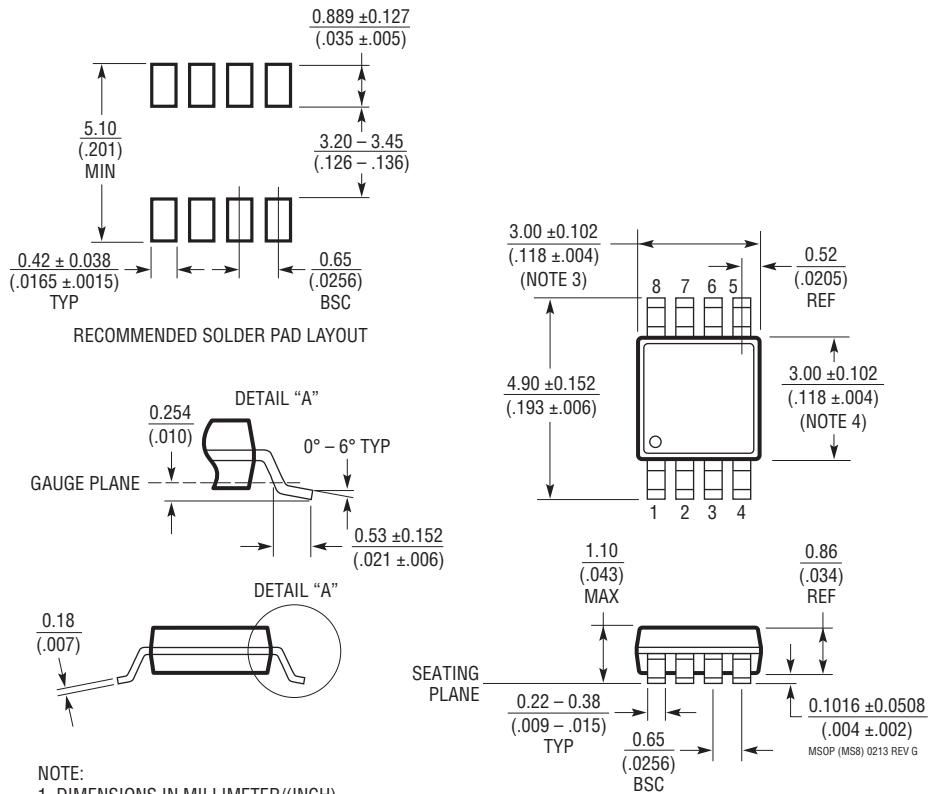


Figure 7. Reverse Output Current

PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

MS8 Package 8-Lead Plastic MSOP (LTC DWG # 05-08-1660 Rev G)



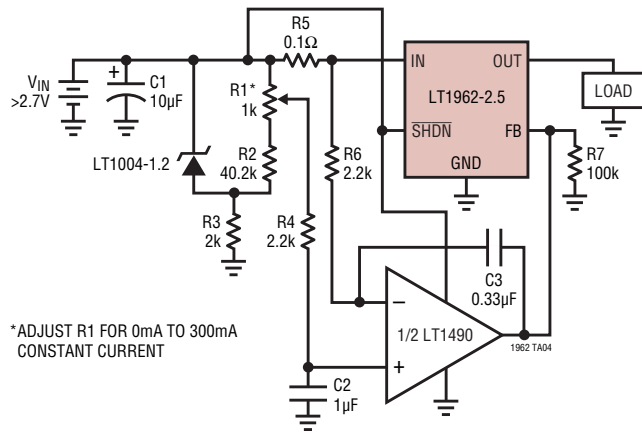
- NOTE:
1. DIMENSIONS IN MILLIMETER/(INCH)
 2. DRAWING NOT TO SCALE
 3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
 4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
 5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

REVISION HISTORY (Revision history begins at Rev B)

REV	DATE	DESCRIPTION	PAGE NUMBER
B	5/15	Clarified the Order Information table. Added I-grade option.	2 2, 4

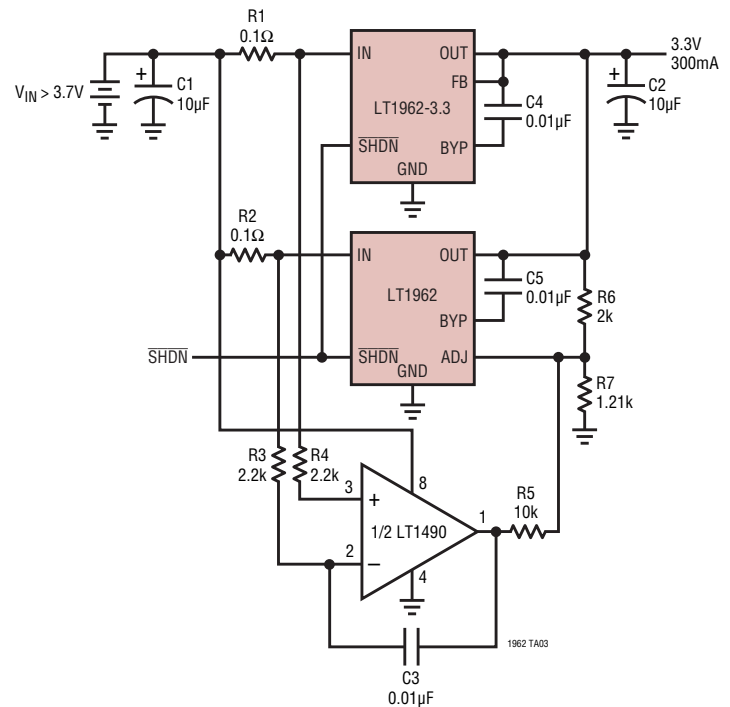
TYPICAL APPLICATION

Adjustable Current Source



*ADJUST R1 FOR 0mA TO 300mA CONSTANT CURRENT

Paralleling of Regulators for Higher Output Current



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1120	125mA Low Dropout Regulator with 20 μ A I_Q	Includes 2.5V Reference and Comparator
LT1121	150mA Micropower Low Dropout Regulator	30 μ A I_Q , SOT-223 Package
LT1129	700mA Micropower Low Dropout Regulator	50 μ A Quiescent Current
LT1175	500mA Negative Low Dropout Micropower Regulator	45 μ A I_Q , 0.26V Dropout Voltage, SOT-223 Package
LT1521	300mA Low Dropout Micropower Regulator with Shutdown	15 μ A I_Q , Reverse Battery Protection
LT1529	3A Low Dropout Regulator with 50 μ A I_Q	500mV Dropout Voltage
LTC[®]1627	High Efficiency Synchronous Step-Down Switching Regulator	Burst Mode™ Operation, Monolithic, 100% Duty Cycle
LT1761	100mA, Low Noise, Low Dropout Micropower Regulator in SOT-23	20 μ A Quiescent Current, 20 μ V _{RMS} Noise
LT1762	150mA, Low Noise, LDO Micropower Regulator	25 μ A Quiescent Current, 20 μ V _{RMS} Noise
LT1763	500mA, Low Noise, LDO Micropower Regulator	30 μ A Quiescent Current, 20 μ V _{RMS} Noise
LT1764	3A, Fast Transient Response Low Dropout Regulator	340mV Dropout Voltage, 40 μ V _{RMS} Noise
LTC1772	Constant Frequency Current Mode Step-Down DC/DC Controller	Up to 94% Efficiency, SOT-23 Package, 100% Duty Cycle
LT1963	1.5A, Fast Transient Response Low Dropout Regulator	SO-8, SOT-223 Packages